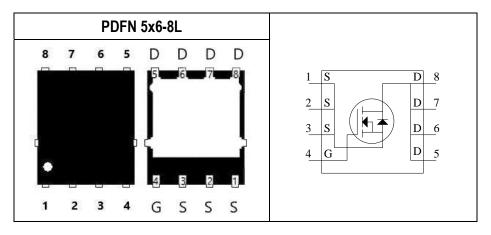


DG-FET™ 85V N-Channel Power MOSFET

Parameter	Value	Unit
V_{DSS}	85	V
R _{DS} (ON) max. V _{GS} =10V	4.7	mΩ
I _D	68.7	Α
Q _g 10V	69.9	nC
Q_{gd}	21.4	nC
Qsw	31.7	nC



Features	Application
Low On-Resistance R _{DS (on)}	Load Switch
Low Input Capacitance	Motor Driving Application
Low Gate Charge	Switch Mode Power Supply
Fully Characterized Capacitance and Avalanche	Laptop and PCs and Network Equipment
Pb-free lead plating; RoHS compliant	MOSFET for synchronous rectification in SMPS

Ordering Information

Ordering Code	RoHS Status	Package	Package Code	Packing	Quantity
DG85N03Q	Halogen-Free	PDFN5x6-8L	D	Tape & Reel	2,500

Absolute Maximum Ratings (T_J=25°C unless otherwise noted)

	Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	85	V
Gate-Source Voltage		V _{GS}	±20	V
Drain Current-Continuous Note 1	T _C =25°C	I-	68.7	Α
Drain Current-Continuous Note	T _C =100°C	- ID	47.6	Α
Desire Courses Continuous Note 2	T _A =25°C		20.4	Α
Drain Current-Continuous Note 2	T _A =70°C	ID	15.2	А
Drain Current-Pulsed Note 3	T _C =25°C	I _{DM}	200	А
Avalanche Current	•	IAR	26	Α
Single Pulse Avalanche Energy Note 4		Eas	33.8	mJ
	T _C =25°C		37.9	W
Maximum Power Dissipation	T _C =100°C	D .	15.1	W
	T _A =25°C	P _D	3.3	W
	T _A =70°C		1.8	W
Operating and Storage Temperature F	Range	TJ, TSTG	-55 to 150	°C

Thermal Resistance Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal resistance, Junction-Case Note 5	R _{θJC}	Steady State	-	-	3.29	°C/W
Thermal resistance, Junction-Ambient Note 5	RеJA	Steady State	-	-	37.32	°C/W

Notes:

- 1. Limited by silicon chip capability and $R_{\theta JC}$ junction-to-case thermal resistance.
- 2. The maximum current rating is limited by package and $R_{\theta JA}$ junction-to-ambient thermal resistance.
- 3. Must be ensure junction temperature does not exceed 150-degree C. (Pulse Width \leq 100uS, Duty \leq 2%)
- 4. Limited by T_{Jmax} , starting T_J =25°C, L=0.1mH, R_g =25 Ω , I_D =26A, V_{GS} =10V.
- 5. The value of thermal resistance is measured with the single device mounted on 1 inch² FR-4 PCB with 2 Ounce copper under a still air environment temperature is 25degree C. Thermal resistance obtained depends on the user's specific board design and given application.



DG-FET™ 85V N-Channel Power MOSFET

Electrical Characteristics (T_J=25°C unless otherwise noted)

STATIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _{DS} =250μA	85	-	-	V
Zoro Coto Voltago Drain Current	1	V _{DS} =85V, V _{GS} =0V	-	-	1	μΑ
Zero Gate Voltage Drain Current	IDSS	V _{DS} =85V, V _{GS} =0V, T _J =125°C	-	-	100	μΑ
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	=	±100	nA

STATIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =250μA	2.5	2.9	3.2	V
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =10V, I _{DS} =50A	-	4.0	4.7	mΩ
Gate Resistance	R_g	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	1.2	-	Ω
Forward Transconductance	G fs	V _{DS} =5V, I _{DS} =20A	-	25	-	S

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	Ciss	V _{DD} =85V, V _{DS} =40V, V _{GS} =0V, f=1MHz	-	3829	-	pF
Output Capacitance	Coss	V _{DD} =85V, V _{DS} =40V, V _{GS} =0V, f=1MHz	-	862	-	pF
Reverse Transfer Capacitance	C _{rss}	V _{DD} =85V, V _{DS} =40V, V _{GS} =0V, f=1MHz	-	50	-	pF
Turn-On Delay Time	T _{d(on)}	V _{DS} =40V, V _{GS} =10V, I _{DS} =36A, R _{GEN} =3Ω	-	27.9	-	nS
Rise Time	tr	V _{DS} =40V, V _{GS} =10V, I _{DS} =36A, R _{GEN} =3Ω	-	60.9	-	nS
Turn-Off Delay Time	$T_{d(off)}$	V_{DS} =40V, V_{GS} =10V, I_{DS} =36A, R_{GEN} =3 Ω	-	54.9	-	nS
Fall Time	t _f	V _{DS} =40V, V _{GS} =10V, I _{DS} =36A, R _{GEN} =3Ω	-	21.9	-	nS

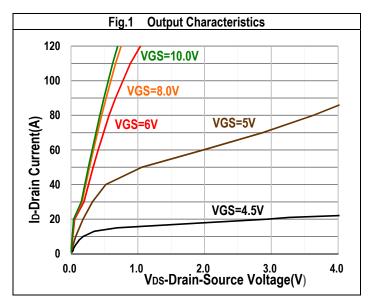
GATE CHARGE CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Gate to Source Gate Charge	Q_{gs}	V _{DD} =40V, I _D =50A, V _{GS} =0 to 10V	-	21.7	-	nC
Gate charge at threshold	$Q_{g(th)}$	V_{DD} =40V, I_D =50A, V_{GS} =0 to 10V	-	11.4	-	nC
Gate to Drain Charge	Q_{gd}	V _{DD} =40V, I _D =50A, V _{GS} =0 to 10V	-	21.4	-	nC
Switching charge	Qsw	V _{DD} =40V, I _D =50A, V _{GS} =0 to 10V	-	31.7	-	nC
Gate charge total	Q _{g 10V}	V _{DD} =40V, I _D =50A, V _{GS} =0 to 10V	-	69.9	-	nC
Gate plateau voltage	V _{plateau}	V _{DD} =40V, I _D =50A, V _{GS} =0 to 10V	-	5.3	-	V
Gate charge total, sync. FET (Q _g - Q _{gd})	Qg(sync)	V _{DS} =0.1V, V _{GS} =0 to 10V	-	48.5	-	nC

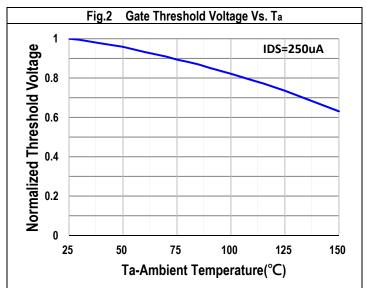
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Body Diode continuous forward current	Is	T _C =25°C	-	-	68.7	Α
Body Diode pulse current	Ism	T _C =25°C	-	-	200	Α
Body Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1A	-	0.7	1.0	V
Body Diode Reverse Recovery Time	4	V _{DD} =40V, I _F =10A, di/dt=100A/µs	-	56	-	nS
Body Diode Reverse Recovery Time	t _{rr}	V _{DD} =40V, I _F =20A, di/dt=200A/µs	-	76.7	-	nS
Body Diode Reverse Recovery Charge	Q _{rr}	V _{DD} =40V, I _F =10A, di/dt=100A/µs	-	45.7	-	nC
Body Diode Reverse Recovery Charge	Q _{rr}	V _{DD} =40V, I _F =20A, di/dt=100A/μs	-	108.8	=	nC

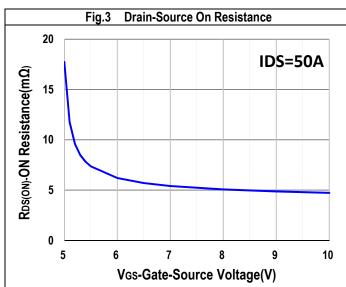


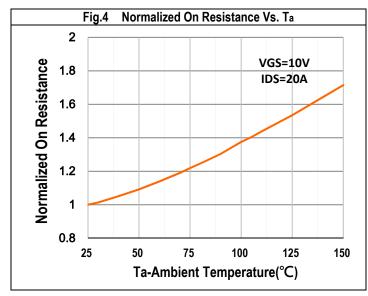
DG-FET™ 85V N-Channel Power MOSFET

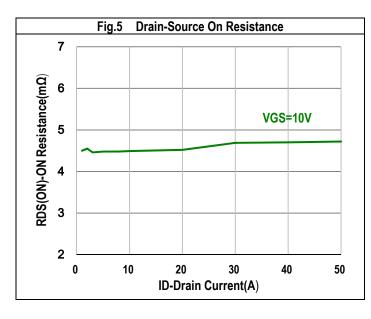
Typical Operating Characteristics

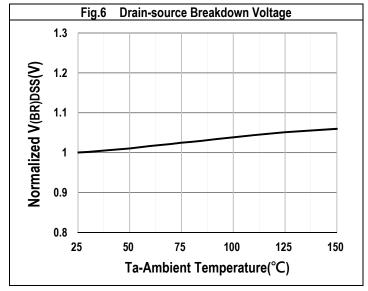








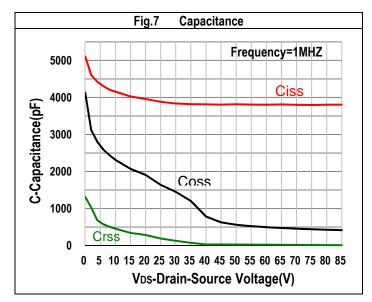


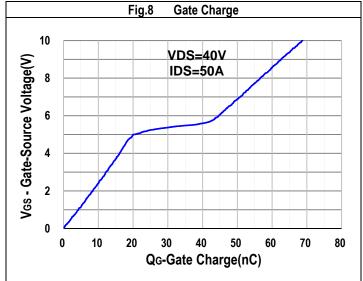


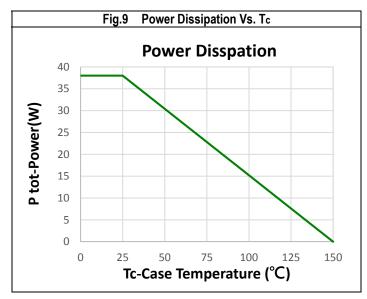


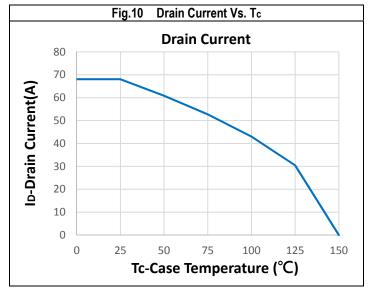
DG-FET™ 85V N-Channel Power MOSFET

Typical Operating Characteristics (Cont.)



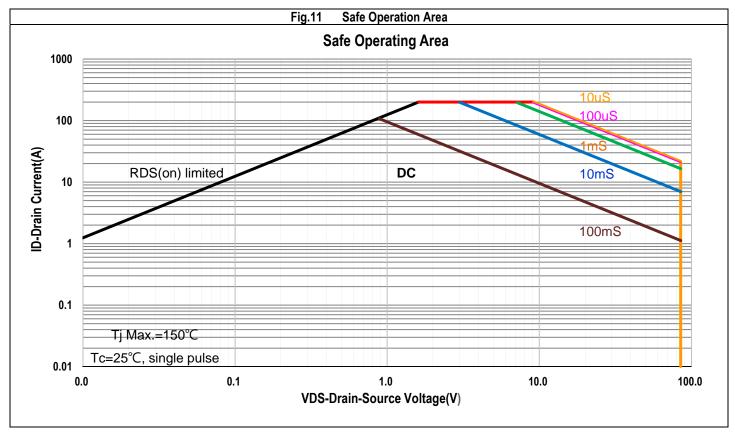


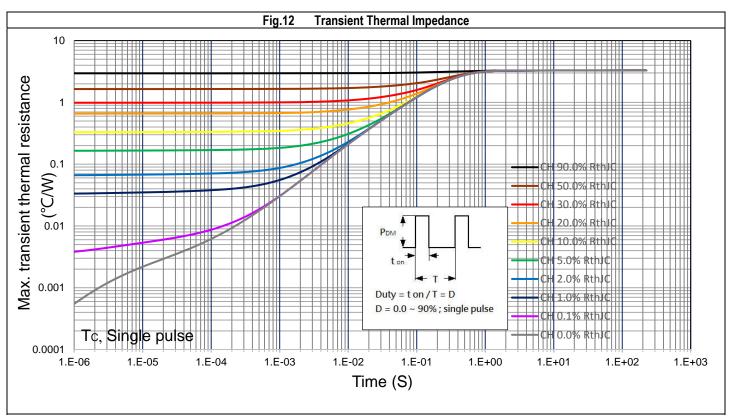






DG-FET™ 85V N-Channel Power MOSFET







DG85N03Q *DG-FET™* 85V N-Channel Power MOSFET

Marking Information

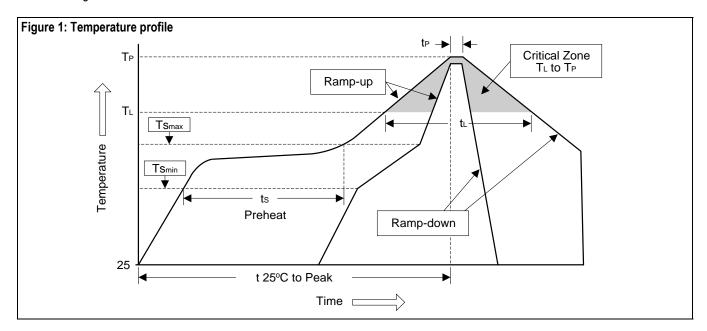
PDFN 5x6-8L (Q)	Marking Rule
Laser Marking	Line 1 : Device
	DG85N03Q
DG85N03Q YYMMXXX	Line 2 : Date Code YYMMXXX YY : Year Code MM : Month Code XXX : Serial Number



DG-FET™ 85V N-Channel Power MOSFET

Soldering Methods for Silicongear's Products

- 1. Storage environment: Temperature=10°C to 35°C Humidity=65%±15%
- 2. Reflow soldering of surface-mount devices



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	<3°C/sec	<3°C/sec
Preheat		
- Temperature Min (Ts _{min})	100°C	150°C
- Temperature Max (Ts _{max})	150°C	200°C
- Time (min to max) (ts)	60 to 120 sec	60 to 180 sec
Tsmax to T∟		
- Ramp-up Rate	<3°C/sec	<3°C/sec
Time maintained above:		
- Temperature (T∟)	183°C	217°C
- Time (t _∟)	60 to 150 sec	60 to 150 sec
Peak Temperature (T _P)	240°C +0/-5°C	260°C +0/-5°C
Time within 5°C of actual Peak	10 to 20 ooo	20 to 40 and
Temperature (t₂)	10 to 30 sec	20 to 40 sec
Ramp-down Rate	<6°C/sec	<6°C/sec
Time 25°C to Peak Temperature	<6 minutes	<8 minutes

3. Flow (wave) soldering (solder dipping)

Products	Peak Temperature	Dipping Time
Pb devices.	245°C ±5°C	5sec ±1sec
Pb-Free devices.	260°C +0/-5°C	5sec ±1sec



DG-FET™ 85V N-Channel Power MOSFET

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